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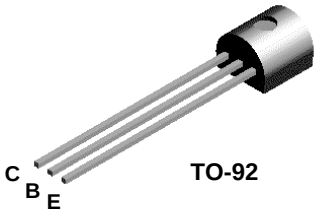
FAIRCHILD SEMICONDUCTOR TM

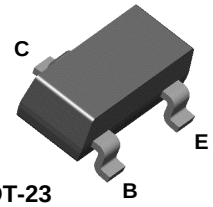
Jameco Part Number 214674

# 2N4124




TO-92

# MMBT4124




SOT-23
**Mark: ZC**

## NPN General Purpose Amplifier

This device is designed as a general purpose amplifier and switch. The useful dynamic range extends to 100 mA as a switch and to 100 MHz as an amplifier.

### Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|---|---|---|---|
| $V_{CEO}$ | Collector-Emitter Voltage | 25 | V |
| $V_{CBO}$ | Collector-Base Voltage | 30 | V |
| $V_{EBO}$ | Emitter-Base Voltage | 5.0 | V |
| $I_C$ | Collector Current - Continuous | 200 | mA |
| $T_J$, $T_{stg}$ | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

**NOTES**:
**1)** These ratings are based on a maximum junction temperature of 150 degrees C.
**2)** These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol | Characteristic | Max | | Units |
|---|---|---|---|---|
| | | 2N4124 | *MMBT4124 | |
| $P_D$ | Total Device Dissipation<br>Derate above 25°C | 625<br>5.0 | 350<br>2.8 | mW<br>mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | 357 | °C/W |

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

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## NPN General Purpose Amplifier
(continued)

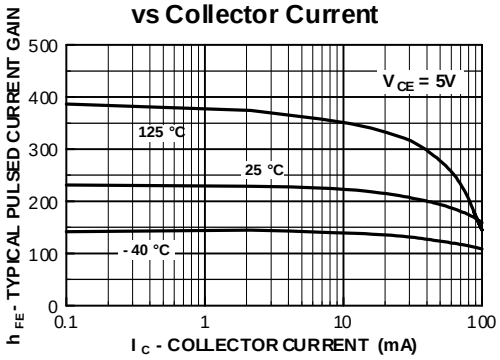
### Electrical Characteristics
TA = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage | $I_C$ = 1.0 mA, $I_B$ = 0 | 25 | | V |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C$ = 10 µA, $I_E$ = 0 | 30 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_C$ = 10 µA, $I_C$ = 0 | 5.0 | | V |
| $I_{CBO}$ | Collector Cutoff Current | $V_{CB}$ = 20 V, $I_E$ = 0 | | 50 | nA |
| $I_{EBO}$ | Emitter Cutoff Current | $V_{EB}$ = 3.0 V, $I_C$ = 0 | | 50 | nA |
| **ON CHARACTERISTICS*** | | | | | |
| $h_{FE}$ | DC Current Gain | $I_C$ = 2.0 mA, $V_{CE}$ = 1.0 V<br>$I_C$ = 50 mA, $V_{CE}$ = 1.0 V | 120<br>60 | 360 | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C$ = 50 mA, $I_B$ = 5.0 mA | | 0.3 | V |
| $V_{BE(sat)}$ | Base-Emitter Saturation Voltage | $I_C$ = 50 mA, $I_B$ = 5.0 mA | | 0.95 | V |
| **SMALL SIGNAL CHARACTERISTICS** | | | | | |
| $f_T$ | Current Gain - Bandwidth Product | $I_C$ = 10 mA, $V_{CE}$ = 20 V,<br>f = 100 MHz | 300 | | MHz |
| $C_{obo}$ | Output Capacitance | $V_{CB}$ = 5.0 V, $I_E$ = 0,<br>f = 100 kHz | | 4.0 | pF |
| $C_{ibo}$ | Input Capacitance | $V_{BE}$ = 0.5 V, $I_C$ = 0,<br>f = 1.0 kHz | | 8.0 | pF |
| $C_{cb}$ | Collector-Base Capcitance | $V_{CB}$ = 5.0 V, $I_E$ = 0,<br>f = 100 kHz | | 4.0 | pF |
| $h_{fe}$ | Small-Signal Current Gain | $V_{CE}$ = 10 V, $I_C$ = 2.0 mA,<br>f = 1.0 kHz | 120 | 480 | |
| NF | Noise Figure | $I_C$ = 100 µA, $V_{CE}$ = 5.0 V,<br>$R_S$ =1.0kΩ, f=10 Hz to 15.7 kHz | | 5.0 | dB |

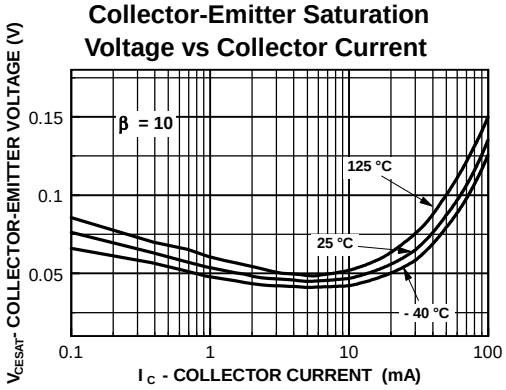
*Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%

## Typical Characteristics

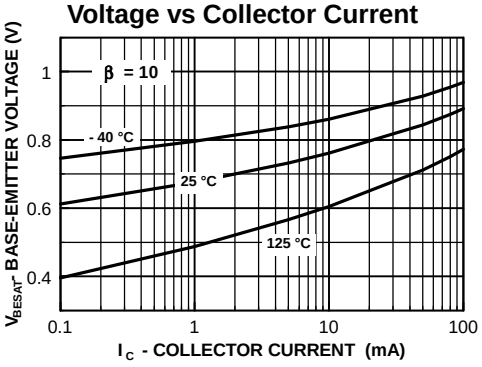
**Typical Pulsed Current Gain vs Collector Current**



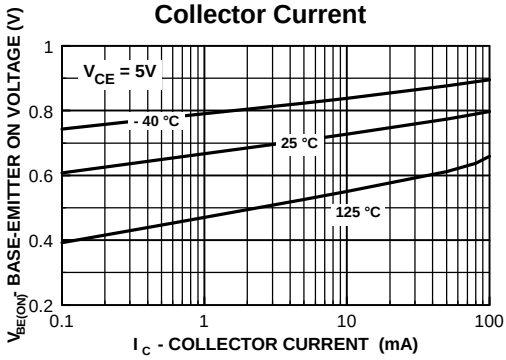

**Collector-Emitter Saturation Voltage vs Collector Current**



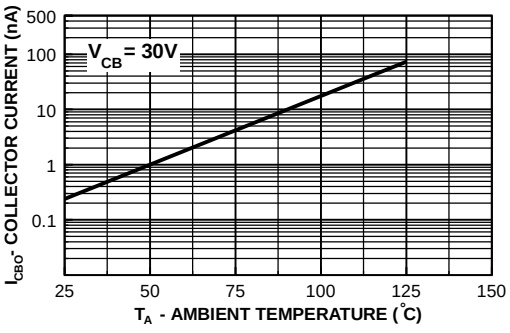

**Base-Emitter Saturation Voltage vs Collector Current**



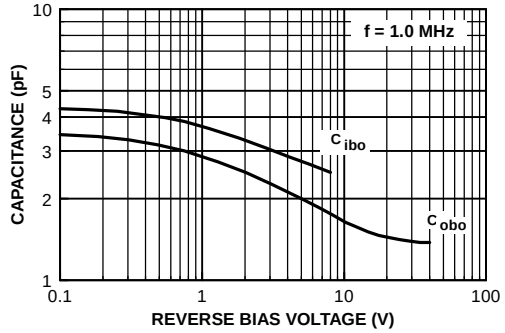

**Base-Emitter ON Voltage vs Collector Current**




**Collector-Cutoff Current vs Ambient Temperature**

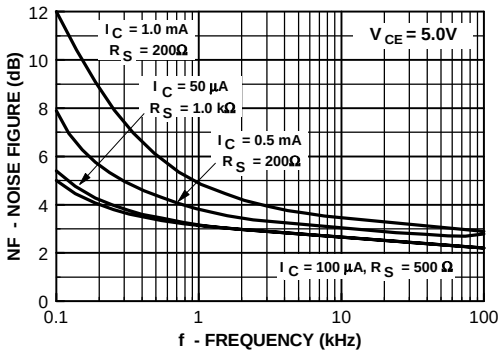



**Capacitance vs Reverse Bias Voltage**

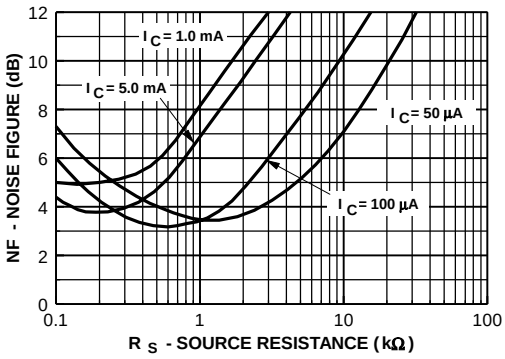


## Typical Characteristics (continued)

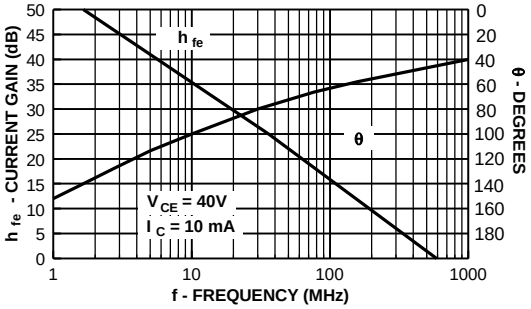
### Noise Figure vs Frequency



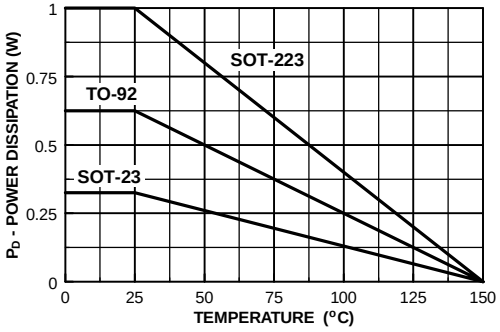

### Noise Figure vs Source Resistance



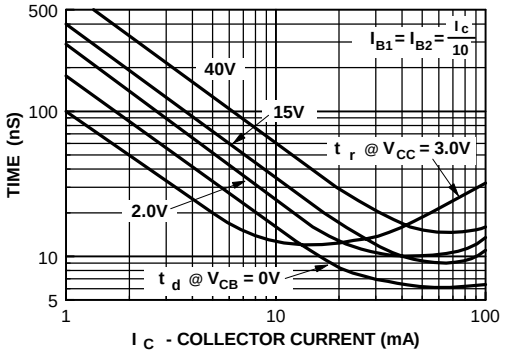

### Current Gain and Phase Angle vs Frequency



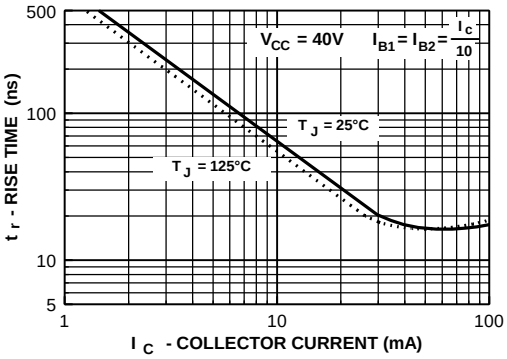

### Power Dissipation vs Ambient Temperature




### Turn-On Time vs Collector Current

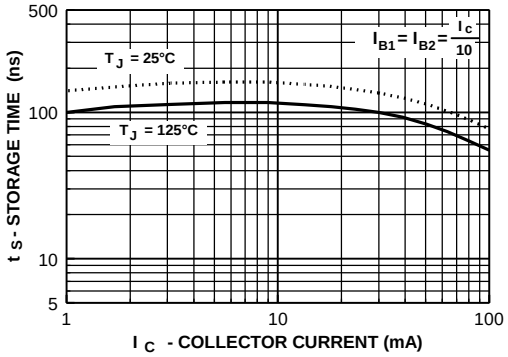



### Rise Time vs Collector Current

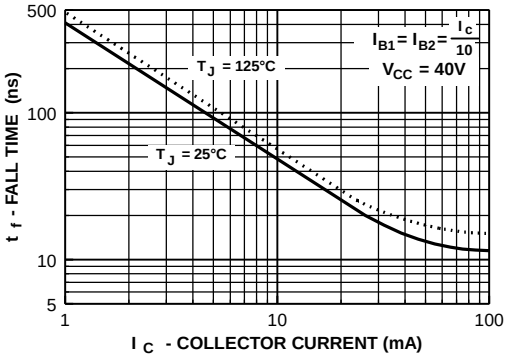


## Typical Characteristics (continued)

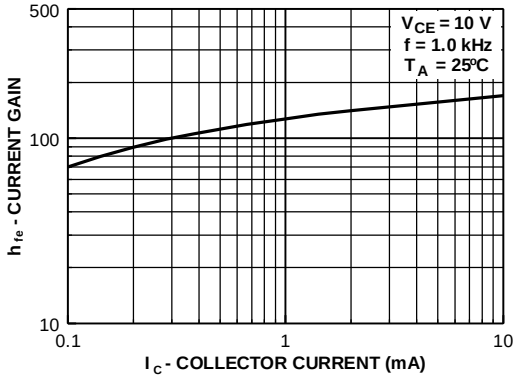
### Storage Time vs Collector Current



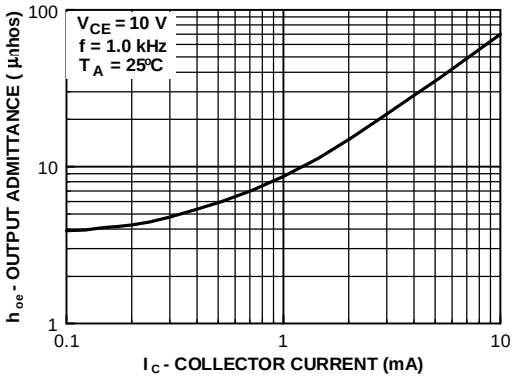

### Fall Time vs Collector Current



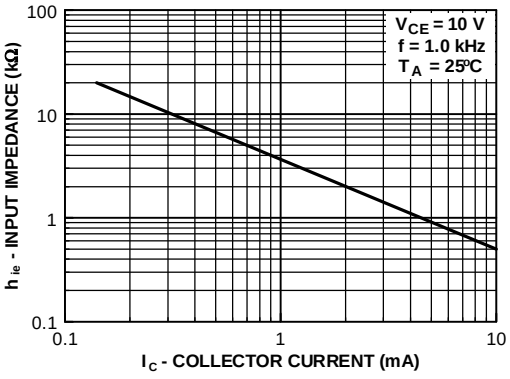

### Current Gain



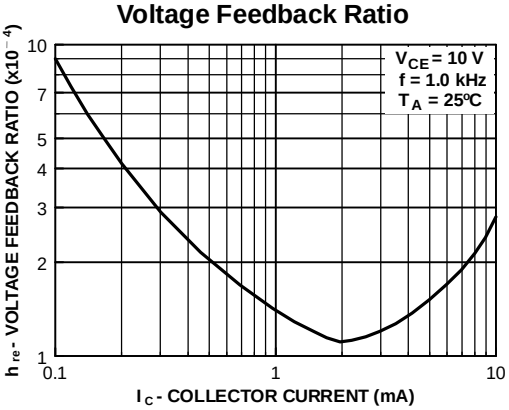

### Output Admittance




### Input Impedance




### Voltage Feedback Ratio



## NPN General Purpose Amplifier
(continued)

### Test Circuits

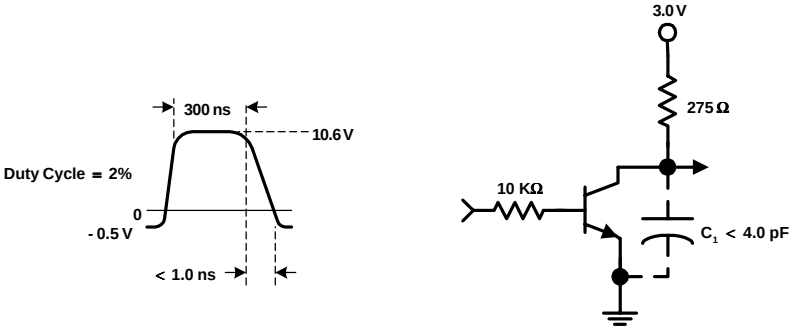



**FIGURE 1: Delay and Rise Time Equivalent Test Circuit**

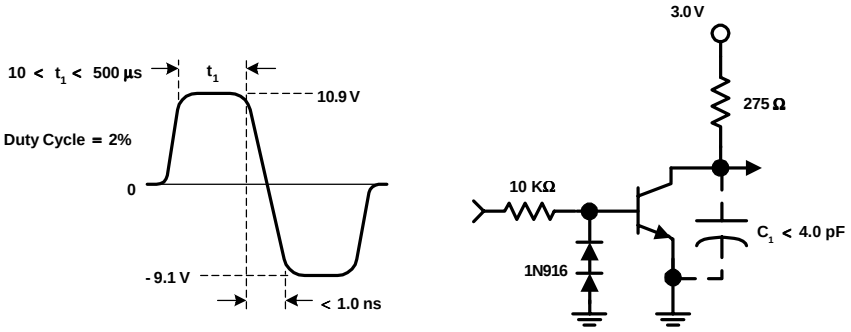


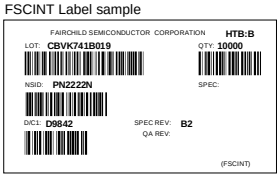

**FIGURE 2: Storage and Fall Time Equivalent Test Circuit**

# TO-92 Tape and Reel Data

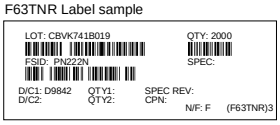
FAIRCHILD SEMICONDUCTOR TM

## TO-92 Packaging Configuration: Figure 1.0

FSCINT Label sample

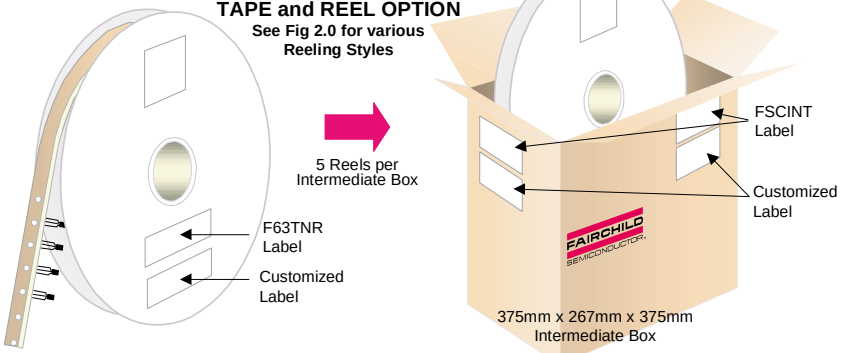



F63TNR Label sample




### TAPE and REEL OPTION

**See Fig 2.0 for various Reeling Styles**



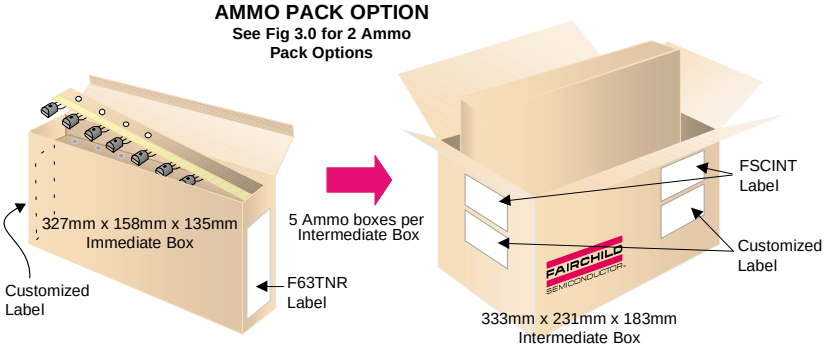

### TO-92 TNR/AMMO PACKING INFROMATION

| Packing | Style | Quantity | EOL code |
|---|---|---|---|
| Reel | A | 2,000 | D26Z |
| | E | 2,000 | D27Z |
| Ammo | M | 2,000 | D74Z |
| | P | 2,000 | D75Z |

Unit weight = 0.22 gm
Reel weight with components = 1.04 kg
Ammo weight with components = 1.02 kg
Max quantity per intermediate box = 10,000 units

### AMMO PACK OPTION

**See Fig 3.0 for 2 Ammo Pack Options**

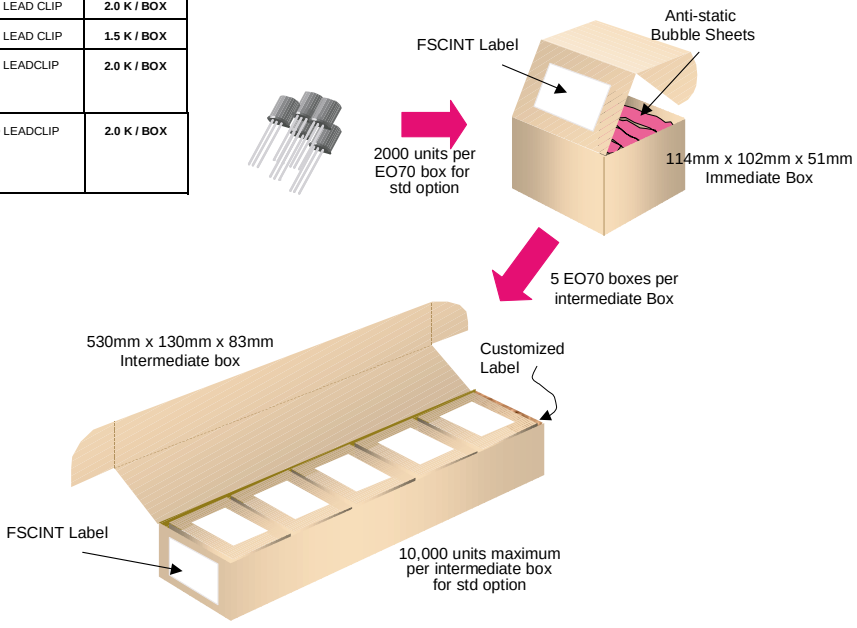

327mm x 158mm x 135mm Immediate Box
Customized Label
5 Ammo boxes per Intermediate Box
F63TNR Label
FSCINT Label
Customized Label
333mm x 231mm x 183mm Intermediate Box

### (TO-92) BULK PACKING INFORMATION

| EOL CODE | DESCRIPTION | LEADCLIP DIMENSION | QUANTITY |
|---|---|---|---|
| J18Z | TO-18 OPTION STD | NO LEAD CLIP | 2.0 K / BOX |
| J05Z | TO-5 OPTION STD | NO LEAD CLIP | 1.5 K / BOX |
| NO EOL CODE | TO-92 STANDARD STRAIGHT FOR: PKG 92, 94 (NON PROELECTRON SERIES), 96 | NO LEADCLIP | 2.0 K / BOX |
| L34Z | TO-92 STANDARD STRAIGHT FOR: PKG 94 (PROELECTRON SERIES BCXXX, BFXXX, BSRXXX), 97, 98 | NO LEADCLIP | 2.0 K / BOX |

### BULK OPTION

**See Bulk Packing Information table**


FSCINT Label
Anti-static Bubble Sheets
2000 units per EO70 box for std option
114mm x 102mm x 51mm Immediate Box
5 EO70 boxes per intermediate Box
530mm x 130mm x 83mm Intermediate box
Customized Label
FSCINT Label
10,000 units maximum per intermediate box for std option

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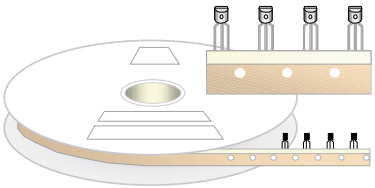
# TO-92 Tape and Reel Data, continued

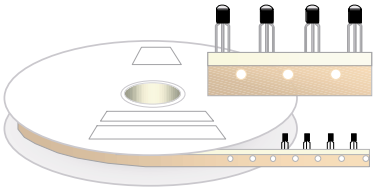
**TO-92 Reeling Style**
**Configuration:** Figure 2.0

**Machine Option “A” (H)**



**Style “A”, D26Z, D70Z (s/h)**

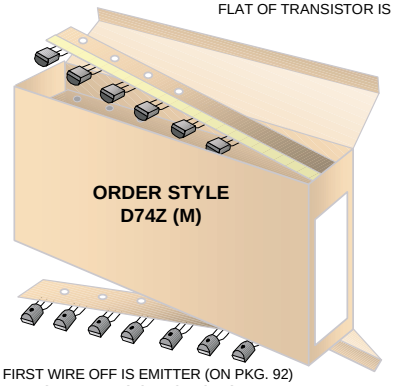
**Machine Option “E” (J)**



**Style “E”, D27Z, D71Z (s/h)**

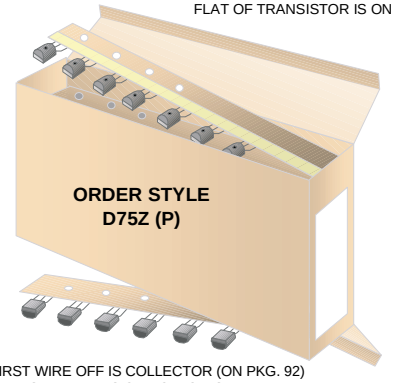
**TO-92 Radial Ammo Packaging**
**Configuration:** Figure 3.0

FIRST WIRE OFF IS COLLECTOR
ADHESIVE TAPE IS ON THE TOP SIDE
FLAT OF TRANSISTOR IS ON TOP




FIRST WIRE OFF IS EMITTER (ON PKG. 92)
ADHESIVE TAPE IS ON BOTTOM SIDE
FLAT OF TRANSISTOR IS ON BOTTOM

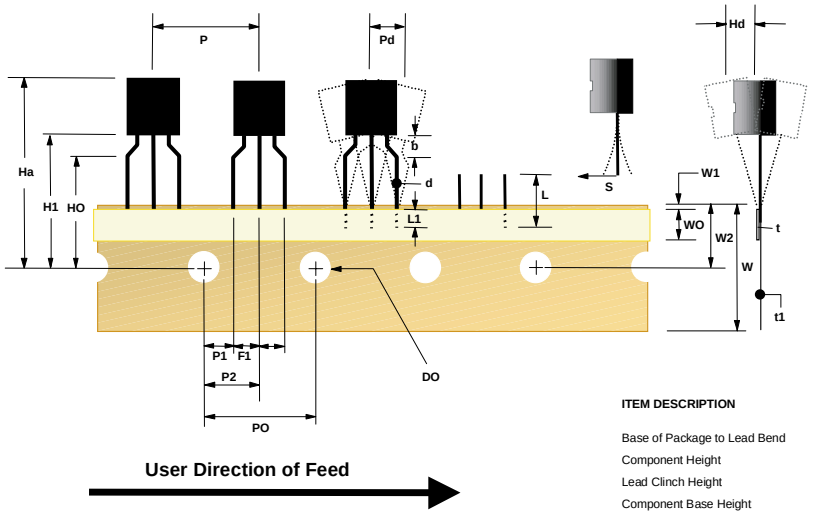
FIRST WIRE OFF IS EMITTER
ADHESIVE TAPE IS ON THE TOP SIDE
FLAT OF TRANSISTOR IS ON BOTTOM




FIRST WIRE OFF IS COLLECTOR (ON PKG. 92)
ADHESIVE TAPE IS ON BOTTOM SIDE
FLAT OF TRANSISTOR IS ON TOP

# TO-92 Tape and Reel Data, continued

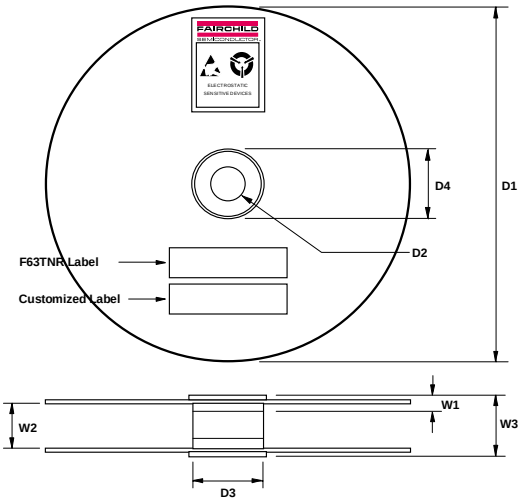
## TO-92 Tape and Reel Taping
**Dimension Configuration:** Figure 4.0




| ITEM DESCRIPTION | SYMBOL | DIMENSION |
|---|---|---|
| Base of Package to Lead Bend | b | 0.098 (max) |
| Component Height | Ha | 0.928 (+/- 0.025) |
| Lead Clinch Height | HO | 0.630 (+/- 0.020) |
| Component Base Height | H1 | 0.748 (+/- 0.020) |
| Component Alignment ( side/side ) | Pd | 0.040 (max) |
| Component Alignment ( front/back ) | Hd | 0.031 (max) |
| Component Pitch | P | 0.500 (+/- 0.020) |
| Feed Hole Pitch | PO | 0.500 (+/- 0.008) |
| Hole Center to First Lead | P1 | 0.150 (+0.009, -0.010) |
| Hole Center to Component Center | P2 | 0.247 (+/- 0.007) |
| Lead Spread | F1/F2 | 0.104 (+/- 0 .010) |
| Lead Thickness | d | 0.018 (+0.002, -0.003) |
| Cut Lead Length | L | 0.429 (max) |
| Taped Lead Length | L1 | 0.209 (+0.051, -0.052) |
| Taped Lead Thickness | t | 0.032 (+/- 0.006) |
| Carrier Tape Thickness | t1 | 0.021 (+/- 0.006) |
| Carrier Tape Width | W | 0.708 (+0.020, -0.019) |
| Hold - down Tape Width | WO | 0.236 (+/- 0.012) |
| Hold - down Tape position | W1 | 0.035 (max) |
| Feed Hole Position | W2 | 0.360 (+/- 0.025) |
| Sprocket Hole Diameter | DO | 0.157 (+0.008, -0.007) |
| Lead Spring Out | S | 0.004 (max) |

Note : All dimensions are in inches.

## TO-92 Reel
**Configuration:** Figure 5.0



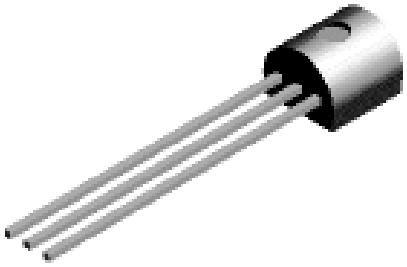

| ITEM DESCRIPTION | SYSMBOL | MINIMUM | MAXIMUM |
|---|---|---|---|
| Reel Diameter | D1 | 13.975 | 14.025 |
| Arbor Hole Diameter (Standard) | D2 | 1.160 | 1.200 |
| (Small Hole) | D2 | 0.650 | 0.700 |
| Core Diameter | D3 | 3.100 | 3.300 |
| Hub Recess Inner Diameter | D4 | 2.700 | 3.100 |
| Hub Recess Depth | W1 | 0.370 | 0.570 |
| Flange to Flange Inner Width | W2 | 1.630 | 1.690 |
| Hub to Hub Center Width | W3 | | 2.090 |

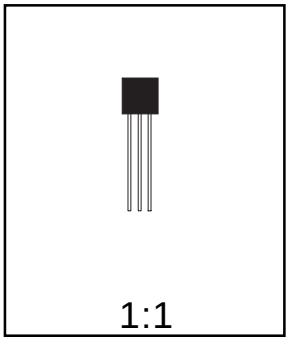
Note: All dimensions are inches

## TO-92 Package Dimensions

FAIRCHILD SEMICONDUCTOR™

# TO-92 (FS PKG Code 92, 94, 96)





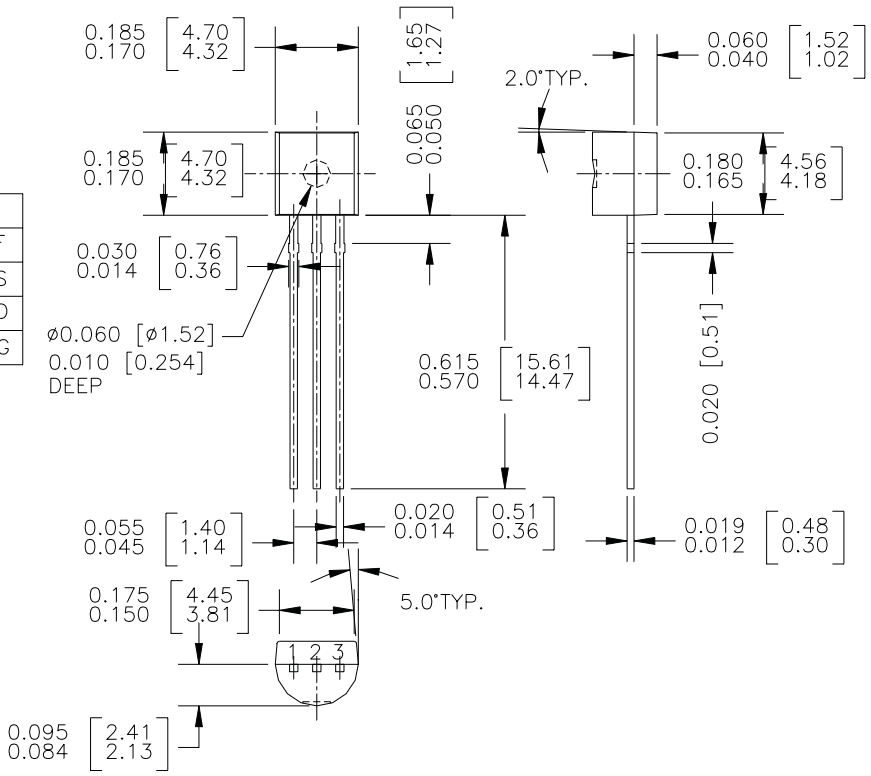

Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.1977

TO−92 (92,94,96)

| PIN | 92 | | 94 | | 96 | |
|---|---|---|---|---|---|---|
| | B | F | B | F | B | F |
| 1 | E | D | E | D | B | S |
| 2 | B | S | C | G | E | D |
| 3 | C | G | B | S | C | G |

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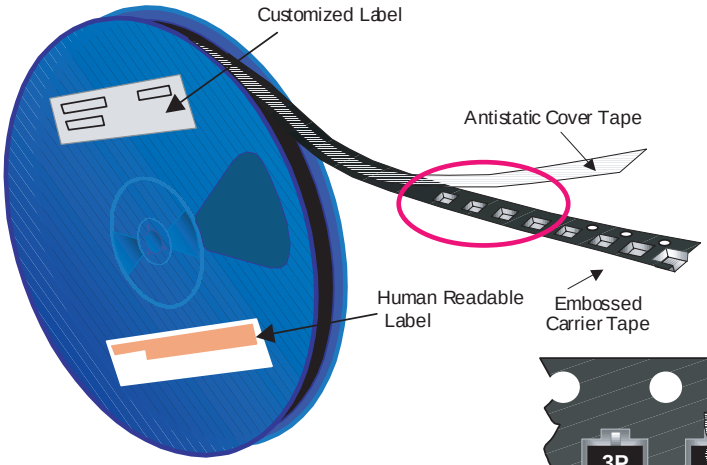
# SOT-23 Tape and Reel Data

FAIRCHILD SEMICONDUCTOR™

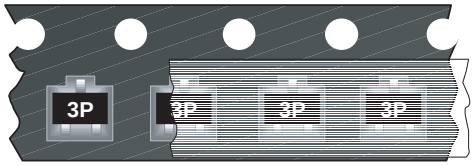
## SOT-23 Packaging Configuration: Figure 10




**Packaging Description:**

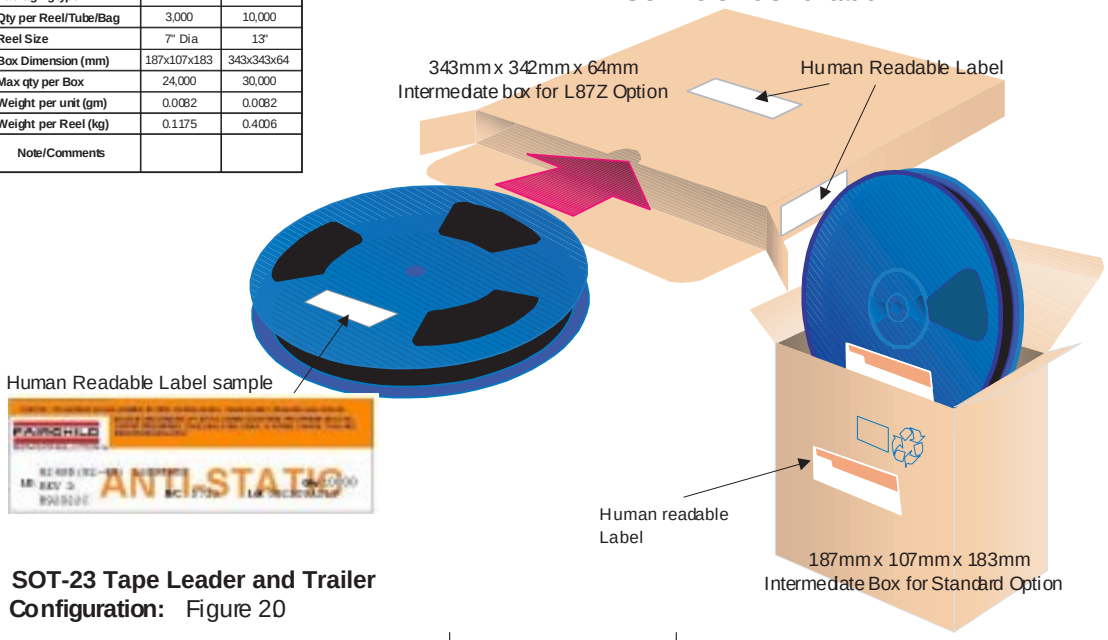
SOT-23 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177cm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330cm diameter reel. This and some other options are described in the Packaging Information table.

These full reels are individually labeled and placed inside a standard intermediate made of recyclable corrugated brown paper with a Fairchild logo printing. One pizza box contains eight reels maximum. And these intermediate boxes are placed inside a labeled shipping box which comes in different sizes depending on the number of parts shipped.

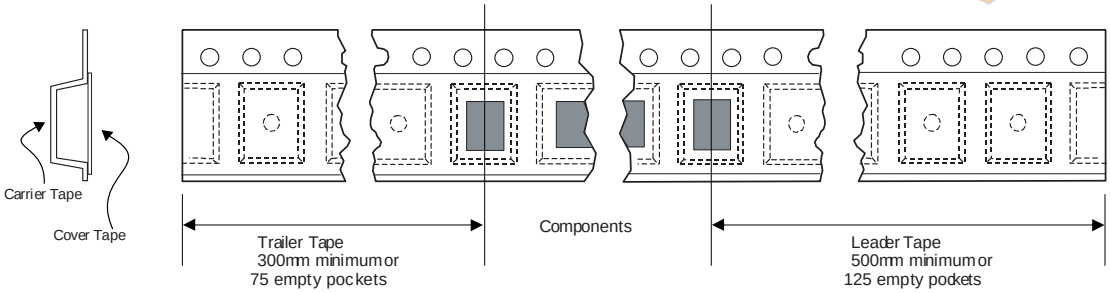



| SOT-23 Packaging Information | | |
|---|---|---|
| Packaging Option | Standard (no flow code) | D87Z |
| Packaging type | TNR | TNR |
| Qty per Reel/Tube/Bag | 3,000 | 10,000 |
| Reel Size | 7" Dia | 13" |
| Box Dimension (mm) | 187x107x183 | 343x343x64 |
| Max qty per Box | 24,000 | 30,000 |
| Weight per unit (gm) | 0.0082 | 0.0082 |
| Weight per Reel (kg) | 0.1175 | 0.4006 |
| Note/Comments | | |

## SOT-23 Unit Orientation




## SOT-23 Tape Leader and Trailer Configuration: Figure 20

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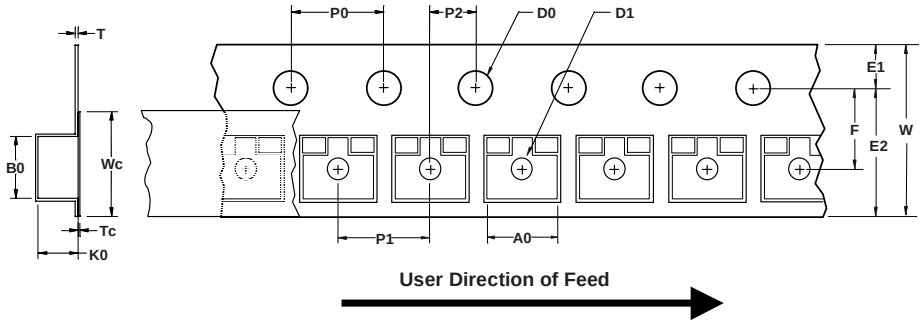
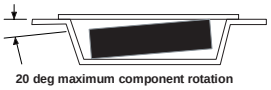
# SOT-23 Tape and Reel Data, continued

## SOT-23 Embossed Carrier Tape
**Configuration:** Figure 3.0

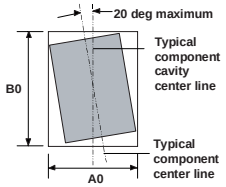



| Dimensions are in millimeter | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| **Pkg type** | **A0** | **B0** | **W** | **D0** | **D1** | **E1** | **E2** | **F** | **P1** | **P0** | **K0** | **T** | **Wc** | **Tc** |
| **SOT-23** (8mm) | 3.15 +/-0.10 | 2.77 +/-0.10 | 8.0 +/-0.3 | 1.55 +/-0.05 | 1.125 +/-0.125 | 1.75 +/-0.10 | 6.25 min | 3.50 +/-0.05 | 4.0 +/-0.1 | 4.0 +/-0.1 | 1.30 +/-0.10 | 0.228 +/-0.013 | 5.2 +/-0.3 | 0.06 +/-0.02 |

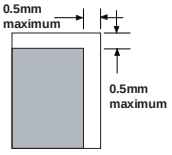
Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).




Sketch A (Side or Front Sectional View)
**Component Rotation**

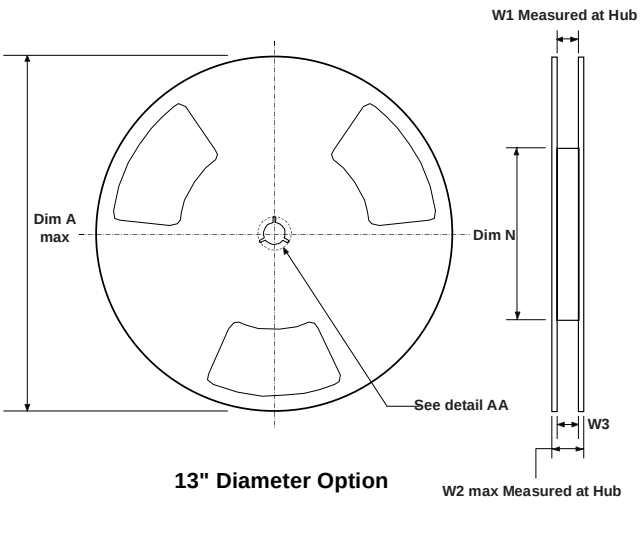



Sketch B (Top View)
**Component Rotation**

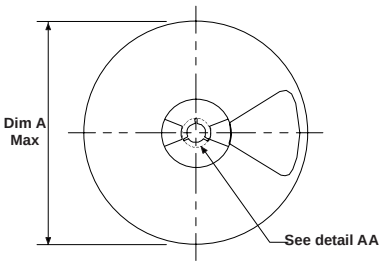



Sketch C (Top View)
**Component lateral movement**

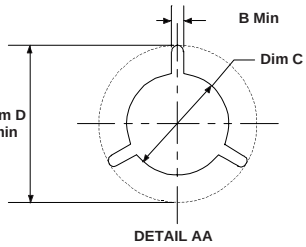
## SOT-23 Reel Configuration: Figure 4.0




**13" Diameter Option**




**7" Diameter Option**




| Dimensions are in inches and millimeters | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|
| **Tape Size** | **Reel Option** | **Dim A** | **Dim B** | **Dim C** | **Dim D** | **Dim N** | **Dim W1** | **Dim W2** | **Dim W3 (LSL-USL)** |
| 8mm | 7" Dia | 7.00 177.8 | 0.059 1.5 | 512 +0.020/-0.008 13 +0.5/-0.2 | 0.795 20.2 | 2.165 55 | 0.331 +0.059/-0.000 8.4 +1.5/0 | 0.567 14.4 | 0.311 – 0.429 7.9 – 10.9 |
| 8mm | 13" Dia | 13.00 330 | 0.059 1.5 | 512 +0.020/-0.008 13 +0.5/-0.2 | 0.795 20.2 | 4.00 100 | 0.331 +0.059/-0.000 8.4 +1.5/0 | 0.567 14.4 | 0.311 – 0.429 7.9 – 10.9 |

## SOT-23 Package Dimensions

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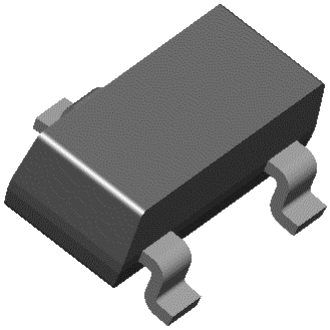
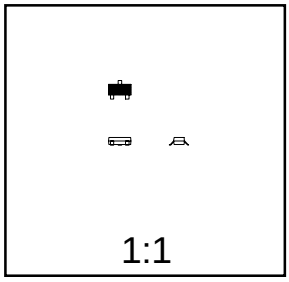
# SOT-23 (FS PKG Code 49)

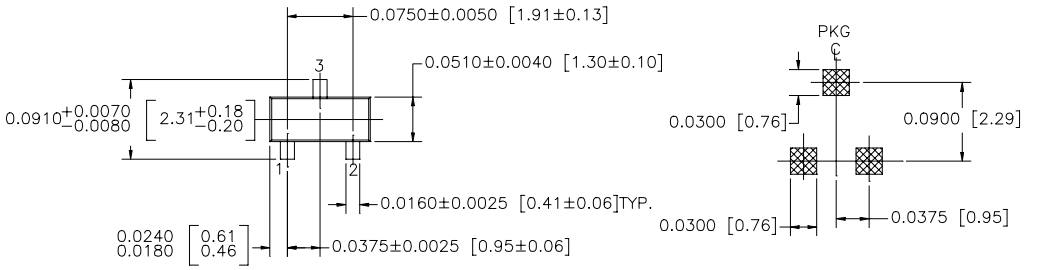


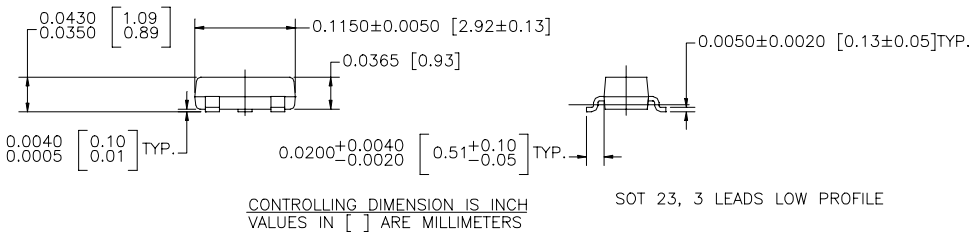



Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.0082




NOTE : UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
2. REFERENCE JEDEC REGISTRATION TO−236, VARIATION AB, ISSUE G, DATED JUL 1993

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